

# MCUXSDKMIMXRT1015RN

## MCUXpresso SDK Release Notes for EVK-MIMXRT1015

Rev. 2.16.000 — 17 June 2024

Release notes

### Document information

| Information | Content   |
|-------------|---|
| Keywords    | MCUXpresso SDK, Release Notes, EVK-MIMXRT1015                                 |
| Abstract    | This document describes the MCUXpresso SDK release notes for EVK-MIMXRT1015 . |



## 1 Overview

The MCUXpresso SDK is a comprehensive software enablement package designed to simplify and accelerate application development with Arm Cortex-M-based devices from NXP, including its general purpose, crossover and Bluetooth-enabled MCUs. MCUXpresso SW and Tools for DSC further extends the SDK support to current 32-bit Digital Signal Controllers. The MCUXpresso SDK includes production-grade software with integrated RTOS (optional), integrated enabling software technologies (stacks and middleware), reference software, and more.

In addition to working seamlessly with the MCUXpresso IDE, the MCUXpresso SDK also supports and provides example projects for IAR, KEIL, and GCC with Cmake. Support for the MCUXpresso Config Tools allows easy cloning of existing SDK examples and demos, allowing users to leverage the existing software examples provided by the SDK for their own projects.

Underscoring our commitment to high quality, the MCUXpresso SDK is MISRA compliant and checked with Coverity static analysis tools. For details on MCUXpresso SDK, see [MCUXpresso-SDK: Software Development Kit for MCUXpresso](#).

## 2 MCUXpresso SDK

As part of the MCUXpresso software and tools, MCUXpresso SDK is the evolution of Kinetis SDK, includes support for LPC, DSC, and i.MX System-on-Chip (SoC). The same drivers, APIs, and middleware are still available with support for Kinetis, LPC, DSC, and i.MX silicon. The MCUXpresso SDK adds support for the MCUXpresso IDE, an Eclipse-based toolchain that works with all MCUXpresso SDKs. Easily import your SDK into the new toolchain to access to all of the available components, examples, and demos for your target silicon. In addition to the MCUXpresso IDE, support for the MCUXpresso Config Tools allows easy cloning of existing SDK examples and demos, allowing users to leverage the existing software examples provided by the SDK for their own projects.

In order to maintain compatibility with legacy Freescale code, the filenames and source code in MCUXpresso SDK containing the legacy Freescale prefix FSL has been left as is. The FSL prefix has been redefined as the NXP Foundation Software Library.

## 3 Development tools

The MCUXpresso SDK is compiled and tested with these development tools:

- Keil MDK, version is 5.39
- MCUXpresso IDE, version is 11.10.0
- GCC Arm Embedded Toolchain 12.3.Rel1
- IAR Embedded Workbench for Arm, version is 9.60

## 4 Supported development system

This release supports boards and devices listed in table below. The boards and devices in bold were tested in this release.

Table 1. Supported boards and devices

| Development boards | MCU devices   |
|--------------------|---|
| EVK-MIMXRT1015     | <b>MIMXRT1015DAF5A</b> , MIMXRT1015CAF4A, MIMXRT1015DAF5A |

5 Release contents

Table 2 provides an overview of the MCUXpresso SDK release package contents and locations.

Table 2. MCUXpresso SDK release package contents and locations

| Deliverable  | Location   |
|--|--|
| Boards   | INSTALL_DIR/boards                                 |
| Demo Applications  | INSTALL_DIR/boards/<board_name>/demo_apps          |
| Driver Examples  | INSTALL_DIR/boards/<board_name>/driver_examples    |
| Board Project Template for MCUXpresso IDE NPW  | INSTALL_DIR/boards/<board_name>/project_template   |
| Driver, SoC header files, extension header files and feature header files, utilities | INSTALL_DIR/devices/<device_name>                  |
| Peripheral drivers   | INSTALL_DIR/devices/<device_name>/drivers          |
| Toolchain linker files and startup code  | INSTALL_DIR/devices/<device_name>/<toolchain_name> |
| Utilities such as debug console  | INSTALL_DIR/devices/<device_name>/utilities        |
| Device Project Template for MCUXpresso IDE NPW                                       | INSTALL_DIR/devices/<device_name>/project_template |
| CMSIS Arm Cortex-M header files, DSP library source                                  | INSTALL_DIR/CMSIS                                  |
| Components and board device drivers  | INSTALL_DIR/components                             |
| RTOS   | INSTALL_DIR/rtos                                   |
| Release Notes, Getting Started Document and other documents                          | INSTALL_DIR/docs                                   |
| Tools such as shared cmake files   | INSTALL_DIR/tools                                  |
| Middleware   | INSTALL_DIR/middleware                             |

6 MCUXpresso SDK release package

The MCUXpresso SDK release package content is aligned with the silicon subfamily it supports. This includes the boards, devices, documentation, and middleware.

6.1 Device support

The device folder contains the whole software enablement available for the specific System-on-Chip (SoC) subfamily. This folder includes clock-specific implementation, device register header files, device register feature header files, and the system configuration source files. Included with the standard SoC support are folders containing peripheral drivers, toolchain support, and a standard debug console. The device-specific header files provide a direct access to the microcontroller peripheral registers. The device header file provides an overall SoC memory mapped register definition. The folder also includes the feature header file for each peripheral on the microcontroller. The toolchain folder contains the startup code and linker files for each supported toolchain. The startup code efficiently transfers the code execution to the main() function.

6.1.1 Board support

The boards folder provides the board-specific demo applications, driver examples, and middleware examples.

### 6.1.2 Demo application and other examples

The demo applications demonstrate the usage of the peripheral drivers to achieve a system level solution. Each demo application contains a readme file that describes the operation of the demo and required setup steps. The driver examples demonstrate the capabilities of the peripheral drivers. Each example implements a common use case to help demonstrate the driver functionality.

## 6.2 Operating System

### 6.2.1 FreeRTOS

Real-time operating system for microcontrollers from Amazon.

### 6.2.2 Azure RTOS

Azure RTOS middleware (FileX, GUIX, LevelX, NetX Duo, USBX) and the ThreadX RTOS are optional components in MCUXpresso SDK. Source code for these items is included in the *rtos/azure-rtos* directory, and examples for the target board are located in *boards/evkbimxrt1015/azure\_rtos\_examples*.

For more information, see the *MCUXpresso SDK Azure RTOS Release Notes* and *Getting Started with MCUXpresso SDK for Azure RTOS*.

## 6.3 Middleware

### 6.3.1 Azure RTOS FileX

A file system based on Azure RTOS.

### 6.3.2 Azure RTOS GUIX

A GUI library based on Azure RTOS.

### 6.3.3 Azure RTOS IoT

A software package that connects to the IoT Hub through Azure RTOS.

### 6.3.4 Azure RTOS LevelX

NOR/NAND Flash wear leveling component

### 6.3.5 Azure RTOS NetX Duo

A network protocol stack based on Azure RTOS.

### 6.3.6 Azure RTOS ThreadX

Azure RTOS ThreadX.

### 6.3.7 Azure RTOS USBX

A USB library based on Azure RTOS.

### 6.3.8 emWin

The MCUXpresso SDK is pre-integrated with the SEGGER emWin GUI middleware. The AppWizard provides developers and designers with a flexible tool to create stunning user interface applications, without writing any code.

### 6.3.9 Fatfs

The FatFs file system is integrated with the MCUXpresso SDK and can be used to access either the SD card or the USB memory stick when the SD card driver or the USB Mass Storage Device class implementation is used.

### 6.3.10 FreeMASTER

FreeMASTER communication driver for 32-bit platforms.

### 6.3.11 IoT Sensing Software Development Kit (ISSDK)

The IoT Sensing Software Development Kit (ISSDK) is the embedded software framework enabling the NXP digital and analog sensors for IoT applications. ISSDK combines a set of robust sensor drivers and algorithms along with example applications that allow users to get started with using NXP IoT motion & pressure sensors. ISSDK is being offered as a middleware component in MCUXpresso SDK.

### 6.3.12 LVGL

LVGL Open Source Graphics Library

### 6.3.13 Motor Control Software (ACIM, BLDC, PMSM)

Motor control examples.

### 6.3.14 MCU Boot

MCU Bootloader source code.

### 6.3.15 USB Host, Device, OTG Stack

See the MCUXpresso SDK USB Stack User's Guide (document MCUXSDKUSBSUG) for more information.

### 6.3.16 USB Type-C Power Delivery Authentication

USB Type-C Power Delivery Authentication

### 6.3.17 USB Type-C PD Stack

See the *MCUXpresso SDK USB Type-C PD Stack User's Guide* (document MCUXSDKUSBPDUG) for more information.

**Note:** *The USB TYPE-C PD stack supports IAR only.*

### 6.3.18 CMSIS DSP Library

The MCUXpresso SDK is shipped with the standard CMSIS development pack, including the prebuilt libraries.

## 7 MISRA compliance

All MCUXpresso SDK drivers comply to MISRA 2012 rules with exceptions in [Table 3](#).

**Table 3. MISRA exception rules**

| Exception rules | Description   |
|-----------------|---|
| Directive 4.4   | Sections of code should not be commented out.   |
| Directive 4.5   | Identifiers in the same name space with overlapping visibility should be typographically unambiguous.   |
| Directive 4.6   | Typedefs that indicate size and signedness should be used in place of the basic numerical types.  |
| Directive 4.8   | If a pointer to a structure or union is never dereferenced within a translation unit, then the implementation of the object should be hidden. |
| Directive 4.9   | A function should be used in preference to a function-like macro where they are interchangeable.  |
| Directive 4.13  | Functions which are designed to provide operations on a resource should be called in an appropriate sequence.                                 |
| Rule 1.2        | Language extensions should not be used.   |
| Rule 2.3        | A project should not contain unused type declarations.  |
| Rule 2.4        | A project should not contain unused tag declarations.   |
| Rule 2.5        | A project should not contain unused macro declarations.   |
| Rule 2.6        | A function should not contain unused label declarations.  |
| Rule 2.7        | There should be no unused parameters in functions.  |
| Rule 4.2        | Trigraphs should not be used.   |
| Rule 5.1        | External identifiers shall be distinct.   |
| Rule 5.4        | Macro identifiers shall be distinct.  |
| Rule 5.9        | Identifiers that define objects or functions with internal linkage should be unique.  |
| Rule 8.7        | Functions and objects should not be defined with external linkage if they are referenced in only one translation unit.                        |
| Rule 8.9        | An object should be defined at block scope if its identifier only appears in a single function.   |
| Rule 8.11       | When an array with external linkage is declared, its size should be explicitly specified.   |
| Rule 8.13       | A pointer should point to a const-qualified type whenever possible.   |
| Rule 10.5       | The value of an expression should not be cast to an inappropriate essential type.   |
| Rule 11.4       | A conversion should not be performed between a pointer to object and an integer type.   |
| Rule 11.5       | A conversion should not be performed from pointer to void into pointer to object.   |
| Rule 12.1       | The precedence of operators within expressions should be made explicit.   |

Table 3. MISRA exception rules...continued

| Exception rules | Description  |
|-----------------|--|
| Rule 12.3       | The comma operator should not be used.   |
| Rule 12.4       | Evaluation of constant expressions should not lead to unsigned integer wrap-around.  |
| Rule 13.3       | A full expression containing an increment (++) or decrement (--) operator should have no other potential side effects other than that caused by the increment or decrement operator. |
| Rule 15.4       | There should be no more than one break or go to statement used to terminate any iteration statement.   |
| Rule 17.5       | The function argument corresponding to a parameter declared to have an array type shall have an appropriate number of elements.  |
| Rule 17.8       | A function parameter should not be modified.   |
| Rule 19.2       | The union keyword should not be used.  |
| Rule 20.1       | #include directives should only be preceded by preprocessor directives or comments.  |
| Rule 20.10      | The # and ## preprocessor operators should not be used.  |
| Rule 21.1       | #define and #undef shall not be used on a reserved identifier or reserved macro name.  |
| Rule 21.2       | A reserved identifier or macro name shall not be declared.   |
| Rule 21.12      | The exception handling features of <fenv.h> should not be used.  |

## 8 Known Issues

This section lists the known issues, limitations, and/or workarounds.

### 8.1 Maximum file path length in Windows 7 operating system

The Windows 7 operating system imposes a 260-character maximum length for file paths. When installing the MCUXpresso SDK, place it in a directory close to the root to prevent file paths from exceeding the maximum character length specified by the Windows operating system. The recommended location is the C:\<folder>.

### 8.2 New Project Wizard compile failure

The following components request the user to manually select other components that they depend upon in order to compile.

These components depend on several other components and the New Project Wizard (NPW) is not able to decide which one is needed by the user.

**Note:** xxx means core variants, such as, cm0plus, cm33, cm4, cm33\_nodsp.

**Components:**issdk\_mag3110, issdk\_host, systick, gpio\_kinetis, gpio\_lpc, issdk\_mpl3115, sensor\_fusion\_agm01, sensor\_fusion\_agm01\_lpc, issdk\_mma845x, issdk\_mma8491q, issdk\_mma865x, issdk\_mma9553, and CMSIS\_RTOS2.

Also for low-level adapter components, currently the different types of the same adapter cannot be selected at the same time.

For example, if there are two types of timer adapters, gpt\_adapter and pit\_adapter, only one can be selected as timer adapter

in one project at a time. Duplicate implementation of the function results in an error.

**Note:** *Most of middleware components have complex dependencies and are not fully supported in new project wizard. Adding a middleware component may result in compile failure.*

### 8.3 RAM targets build issue in CMSIS bsp pack

CMSIS pack does not support different macro definitions for different targets, all RAM targets for projects inside CMSIS BSP PACKs for RT10XX boards will get the same macro definitions with Flash targets, resulting in build failure. To pass build for RAM targets, manually update the XIP\_EXTERNAL\_FLASH and XIP\_BOOT\_HEADER\_ENABLE value to 0 in RTE\_Components.h.

### 8.4 Non XIP target debug issue on toolchain MDK

When debugging non XIP targets in flash boot mode, if application changes any settings which have impacts on flexspi, the build output window might show “Debug access failed” when start debugging next time. It is recommended to keep the board in serial downloader mode when debugging non XIP targets.

### 8.5 CMSIS PACK new project compile failure

The generated configuration cannot be applied globally. The components, serial\_manager\_usb\_cdc\_virtual and serial\_manager\_usb\_cdc\_virtual\_xxx (xxx means core variants like cm0plus, cm33, cm4, and cm33\_nodsp) are unsupported for new project wizard of CMSIS pack and will lead to compile failure if selected while creating new project(s).

### 8.6 Cannot add SDK components into FreeRTOS projects

It is not possible to add any SDK components into FreeRTOS project using the MCUXpresso IDE New Project wizard.

## 9 Change Log

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Change log of software components included in the package, see MCUXpresso SDK ChangeLog\_MIMXRT1015.pdf.



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